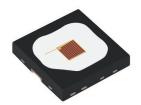
### LR H9PP

#### **OSLON® Black Flat**

OSLON Black Flat is a new small size high-flux LED for slim designs. The black package stands for high stability.





### **Applications**

- Custom Tuning

#### Features:

- Package: SMD epoxy package
- Chip technology: Thinfilm
- Typ. Radiation: 120° (Lambertian emitter)
- − Color:  $λ_{dom}$  = 625 nm (• red)
- Corrosion Robustness Class: 3B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C,
   Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)



Ordering Information		
Туре	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ $\Phi_V$	Ordering Code
LR H9PP-HZJZ-1-1	39 71 lm	Q65111A4286



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T <sub>op</sub>	min. max.	-40 °C 125 °C
Storage Temperature	$T_{stg}$	min. max.	-40 °C 125 °C
Junction Temperature	T <sub>j</sub>	max.	150 °C
Junction Temperature for short time applications*	T <sub>j</sub>	max.	175 °C
Forward current T <sub>S</sub> = 25 °C	I <sub>F</sub>	min. max.	20 mA 1000 mA
Surge Current $t \le 10 \ \mu s; \ D = 0.005 \ ; \ T_s = 25 \ ^{\circ}C$	I <sub>FS</sub>	max.	2500 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	V <sub>ESD</sub>		8 kV
Reverse current 2)	I <sub>R</sub>	max.	200 mA

<sup>\*</sup>The median lifetime (L70/B50) for Tj =175 $^{\circ}$ C is 100h.

#### LR H9PP

### **Characteristics**

 $I_F$  = 350 mA;  $T_S$  = 25 °C

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{\sf peak}$	typ.	632 nm
Dominant Wavelength 3)	$\lambda_{dom}$	min.	620 nm
$I_{\rm F} = 350 \text{ mA}$	dom	typ.	625 nm
		max.	632 nm
Spectral Bandwidth at 50% I <sub>rel,max</sub>	Δλ	typ.	18 nm
Viewing angle at 50 % I <sub>v</sub>	2φ	typ.	120 °
Forward Voltage 4)	$V_{F}$	min.	2.00 V
$I_{\rm F} = 350  \text{mA}$	•	typ.	2.15 V
		max.	2.60 V
Reverse voltage (ESD device)	$V_{R  ESD}$	min.	45 V
Reverse voltage 2)	$V_R$	max.	1.2 V
$I_R = 20 \text{ mA}$			
Real thermal resistance junction/solderpoint <sup>5)</sup>	$R_{ ext{thJS real}}$	typ.	6.5 K / W
	uise real	max.	11.0 K / W
Electrical thermal resistance junction/solderpoint <sup>5)</sup>	R <sub>thJS elec.</sub>	typ.	4.0 K / W
with efficiency $\eta_e$ = 38 %	1100 6166.	max.	6.8 K / W



# **Brightness Groups**

Group	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ min. $\Phi_V$	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ $max.$ $\Phi_V$	Luminous Intensity $^{6)}$ I <sub>F</sub> = 350 mA typ. I <sub>v</sub>
HZ	39 lm	45 lm	14 cd
JX	45 lm	52 lm	16 cd
JY	52 lm	61 lm	19 cd
JZ	61 lm	71 lm	22 cd

# **Forward Voltage Groups**

Group	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 350 mA min. V <sub>F</sub>	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 350 mA max. V <sub>F</sub>	
J3	2.00 V	2.15 V	
M3	2.15 V	2.30 V	
Q3	2.30 V	2.45 V	
T3	2.45 V	2.60 V	



# **Group Name on Label**

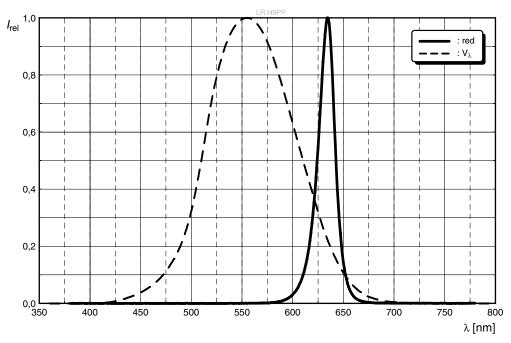
Example: HZ-1-J3

Brightness	Wavelength	Forward Voltage
HZ	1	J3



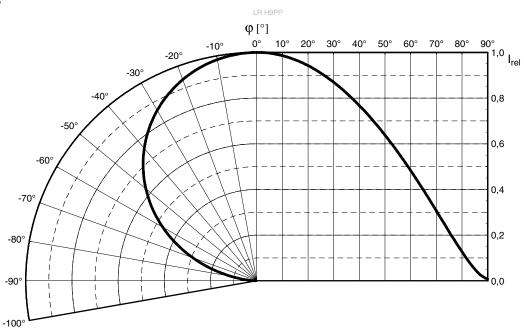
### Relative Spectral Emission 6)

$$\Phi_{rel}$$
 = f ( $\lambda$ );  $I_F$  = 350 mA;  $T_S$  = 25 °C



#### Radiation Characteristics 6)

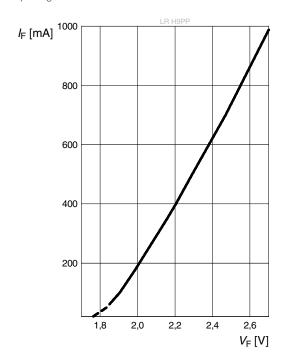
$$I_{rel} = f (\phi); T_S = 25 °C$$





### Forward current 6), 7)

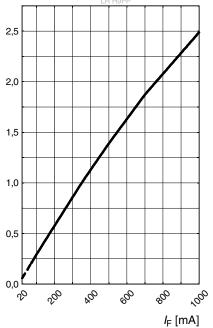
$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



### Relative Luminous Flux 6), 7)

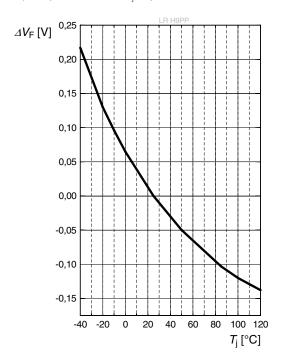
$$\Phi_{V}/\Phi_{V}(350 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$

$$\frac{\Phi_{V}}{\Phi_{V}(350 mA)} = \frac{\Phi_{V}}{2.5}$$



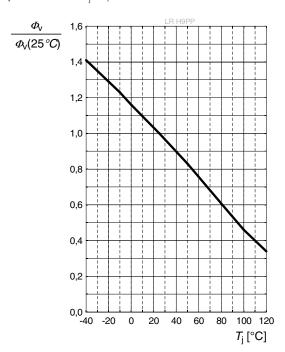
#### Forward Voltage 6)

$$\Delta V_F = V_F - V_F (25 \ ^{\circ}C) = f(T_j); I_F = 350 \ mA$$



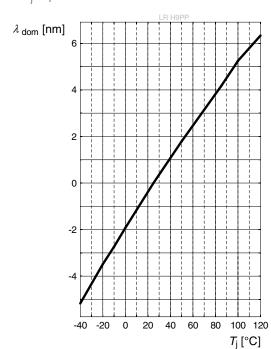
#### Relative Luminous Flux 6)

$$\Phi_{V}/\Phi_{V}(25 \text{ °C}) = f(T_{i}); I_{F} = 350 \text{ mA}$$



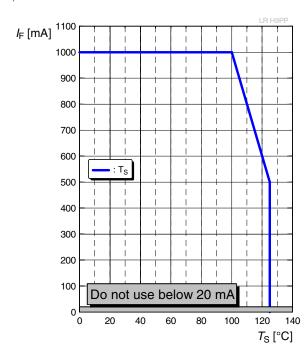
### **Dominant Wavelength** 6)

$$\lambda_{dom} = f(T_j); I_F = 350 \text{ mA}$$



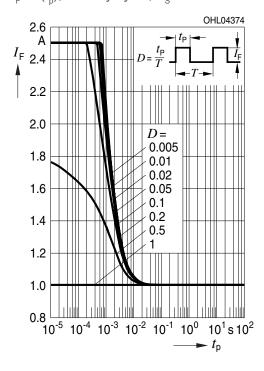
#### Max. Permissible Forward Current

 $I_F = f(T)$ 



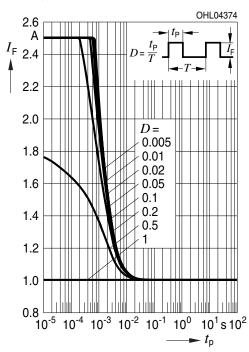
### **Permissible Pulse Handling Capability**

 $I_F = f(t_p)$ ; D: Duty cycle;  $T_S = 25 \, ^{\circ}\text{C}$ 

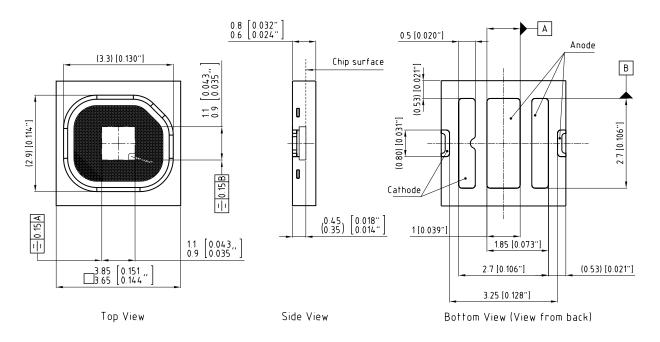


### **Permissible Pulse Handling Capability**

 $I_{_{\rm F}}$  = f(t $_{_{
m D}}$ ); D: Duty cycle;  $T_{_{
m S}}$  = 85 °C



### **Dimensional Drawing** 8)



C67062-A0092-A1-06

**Approximate Weight:** 25.0 mg

Package marking: Cathode

Corrosion test: Class: 3B

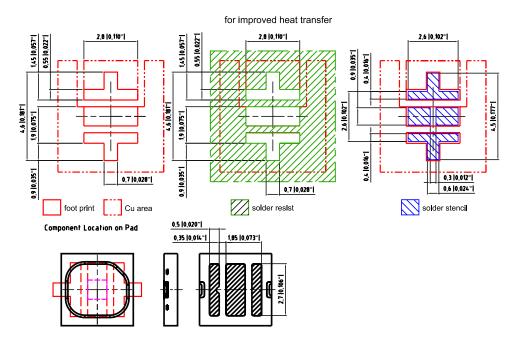
Test condition:  $40^{\circ}$ C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter then IEC

60068-2-43)

**ESD advice:** LED is protected by ESD device which is connected in paralell to LED-Chip.



#### Recommended Solder Pad 8)

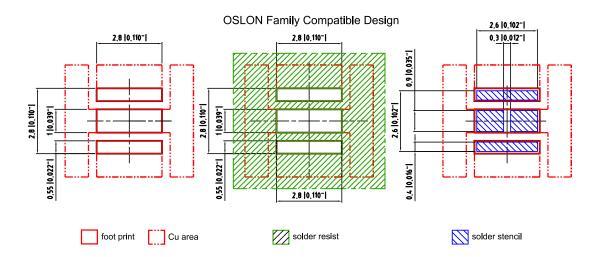


E062.3010.161-01

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. In case the PCB layout of the application is intended to be used with other OSLON derivates or in future developed OSLON derivates, the heat sink must not be electrically connected to anode or cathode solder pad because of possible chip inverted polarity. Package not suitable for ultra sonic cleaning.



#### Recommended Solder Pad 8)



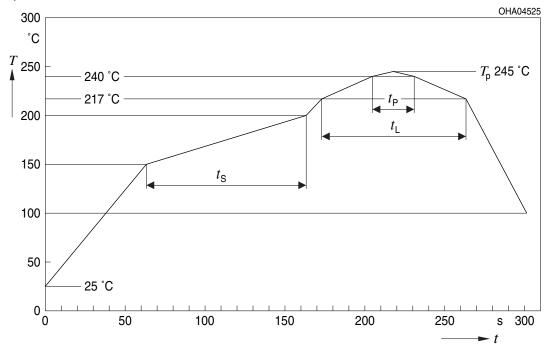
#### E062.3010.160-02

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. In case the PCB layout of the application is intended to be used with other OSLON derivates or in future developed OSLON derivates, the heat sink must not be electrically connected to anode or cathode solder pad because of possible chip inverted polarity. Package not suitable for ultra sonic cleaning.



### **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

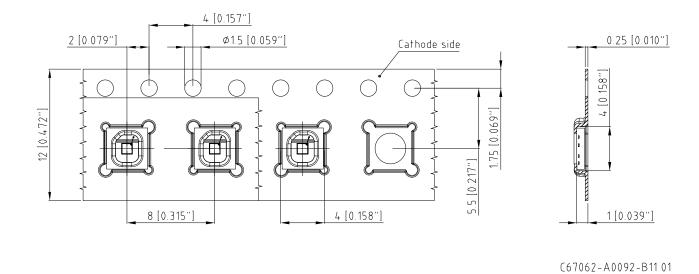


Profile Feature	Symbol Pb-Free (SnAgCu) Asser			sembly	mbly Unit	
		Minimum	Recommendation	Maximum		
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s	
Time $t_s$ $T_{Smin}$ to $T_{Smax}$	t <sub>s</sub>	60	100	120	S	
Ramp-up rate to peak*) $T_{\rm Smax}$ to $T_{\rm P}$			2	3	K/s	
Liquidus temperature	$T_L$		217		°C	
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S	
Peak temperature	T <sub>P</sub>		245	260	°C	
Time within 5 °C of the specified peak temperature T <sub>P</sub> - 5 K	t <sub>P</sub>	10	20	30	S	
Ramp-down rate* T <sub>P</sub> to 100 °C			3	6	K/s	
Time 25 °C to T <sub>P</sub>				480	S	

All temperatures refer to the center of the package, measured on the top of the component  $^{\star}$  slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

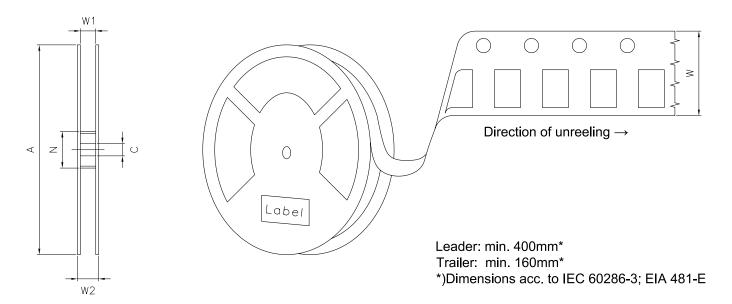


# Taping 8)





# Tape and Reel 9)

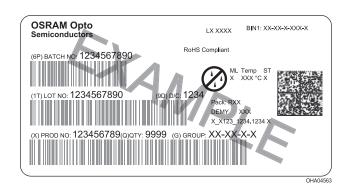


# Reel dimensions [mm]

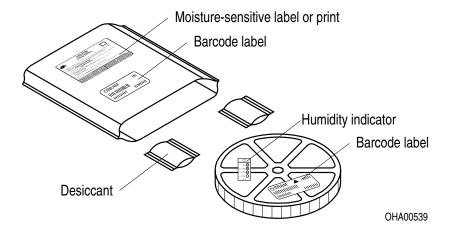
A	W	$N_{min}$	W <sub>1</sub>	$W_{2max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1	60	12.4 + 2	18.4	2000



# **Barcode-Product-Label (BPL)**



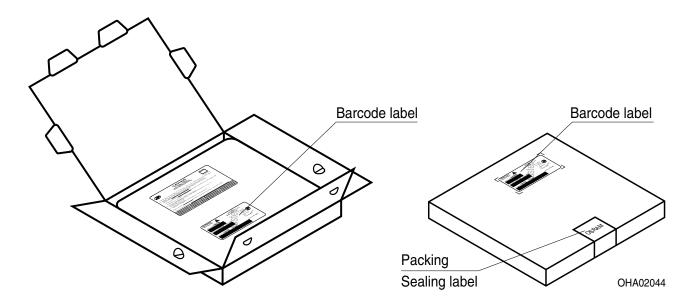
### **Dry Packing Process and Materials 8)**



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



# Transportation Packing and Materials 8)



# Dimensions of transportation box in mm

Width	Length	Height
195 ± 5 mm	195 ± 5 mm	30 ± 5 mm



#### **Type Designation System**

Wavelength **Emission Color** Color coordinates according  $(\lambda_{dom} typ.)$ CIE 1931/Emission color: A: 617 nm amber CY: color on demand yellow S: 633 nm super red **UW:** ultra white **Y**: 587 nm yellow R: 625 nm red Package Type OSLON (QFN) L: Light emitting diode н P P L A 9 **Lead / Package Properties** Standard Ceramos Flash / leadless keep free for further chip developments W: **Encapsulant Type / Lens Properties** planar compression molded silicon (120°); P: with volume conversion planar compression molded silicon (120°); Q: if conversion plätchen **Chip Technology:** power performance P:



#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the LED specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this LED contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize LED exposure to aggressive substances during storage, production, and use. LEDs that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes



#### **Disclaimer**

#### Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS webside.

#### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

In case Buyer - or Customer supplied by Buyer- considers using OSRAM OS components in product safety devices/applications or medical devices/applications, Buyer and/or Customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and Buyer and /or Customer will analyze and coordinate the customer-specific request between OSRAM OS and Buyer and/or Customer.



#### Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8$  % and an expanded uncertainty of  $\pm 11$  % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of k = 3).
- <sup>5)</sup> **Thermal Resistance**: Rth max is based on statistic values (6σ).
- Typical Values: Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single LEDs within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- <sup>9)</sup> **Tape and Reel**: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



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